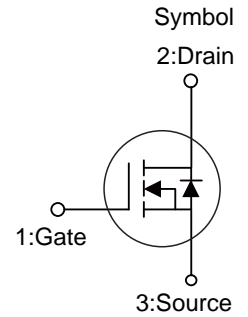


■ PRODUCT CHARACTERISTICS

V _{DSS}	700V
R _{DS(ON)} Typ(@V _{GS} =10V)	0.32Ω
Qg@typ	39nC
I _D	11A

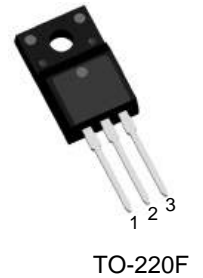


■ APPLICATIONS

- * High efficiency switch mode power supplies
- * Electronic lamp ballasts based on half bridge
- * LED power supplies

■ FEATURE

- * High Switching Speed
- * Improved dv/dt capability



■ ORDER INFORMATION

Order Codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT70R380F	TO-220F	50 pieces/Tube

■ ABSOLUTE MAXIMUM RATINGS(T_A =25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V _{DSS}	700	V
Gate-Source Voltage	V _{GSS}	±30	V
Drain Current Continuous(@V _{GS} =10V, T _A =25°C)	I _D	11	A
Drain Current Pulsed	I _{DM}	44	A
Avalanche Energy *	E _{AS}	250	mJ
Peak Diode Recovery dv/dt	dv/dt	5.0	V/ns
Power Dissipation	P _D	32	W
Junction Temperature	T _J	+150	°C
Storage Temperature	T _{STG}	-55~ +150	°C

■ THERMAL CHARACTERISTICS

Parameter	Symbol	Typ	Unit
Junction to Ambient	R _{thJA}	62.5	°C/W
Junction to Case	R _{thJC}	3.85	°C/W

Note: * EAS condition: T_J=25°C, V_{DD}=50V, V_G=10V, L=20mH, R_g=25Ω

■ ELECTRICAL CHARACTERISTICS ($T_C=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain to Source Breakdown Voltage	V_{DSS}	$V_{GS}=0V, I_D=250\mu A$	700	-	-	V
Drain to Source Leakage Current	I_{DSS}	$V_{DS}=700V, V_{GS}=0V$	-	-	1	μA
Gate to Source Forward Leakage	$I_{GSS(F)}$	$V_{DS}=0V, V_{GS}=+30V$	-	-	100	nA
Gate to Source Reverse Leakage	$I_{GSS(R)}$	$V_{DS}=0V, V_{GS}=-30V$	-	-	-100	nA
On characteristics						
Drain to Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=5.5A$	-	0.32	0.38	Ω
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	-	4	V
Dynamic characteristics						
Gate capacitance	R_g	$V_{GS}=0V, V_{DS}=0V, f=1.0\text{MHz}$	-	19	-	Ω
Forward Transconductance	g_{fs}	$V_{DS}=10V, I_D=3A$	5	-	-	S
Input Capacitance	C_{iss}	$V_{DS}=40V, V_{GS}=0V$ $f=1.0\text{MHz}$	-	760	-	pF
Output Capacitance	C_{oss}		-	247	-	pF
Reverse Transfer Capacitance	C_{rss}		-	14.9	-	pF
Resistive Switching Characteristics						
Turn-on Delay Time	$t_{d(ON)}$	$I_D=5.5A, V_{DS}=350V$ $R_G=10\Omega, V_{GS}=10V$	-	20.4	-	ns
Rise Time	t_r		-	31.2	-	ns
Turn-off Delay Time	$t_{d(OFF)}$		-	83.8	-	ns
Fall Time	t_f		-	13.7	-	ns
Total Gate Charge	Q_g	$I_D=5.5A, V_{DS}=350V$ $V_{GS}=10V$	-	39	-	nC
Gate to Source Charge	Q_{gs}		-	10.3	-	nC
Gate to Drain("Miller") Charge	Q_{gd}		-	13.7	-	nC
Source-Drain Diode Characteristics						
Continuous Source Current(Body Diode)	I_S		-	-	11	A
Maximum Pulsed Current(Body Diode)	I_{SM}		-	-	44	A
Diode Forward Voltage	V_{SD}	$I_{SD}=1A, V_{GS}=0V$	-	0.72	1.2	V
Reverse Recovery Time	t_{rr}	$I_{SD}=5.5A, T_J=25^{\circ}\text{C}$	-	260	-	ns
Reverse Recovery Charge	Q_{rr}	$di/dt=100A/\mu s$	-	2.3	-	μC

■ TYPICAL CHARACTERISTICS

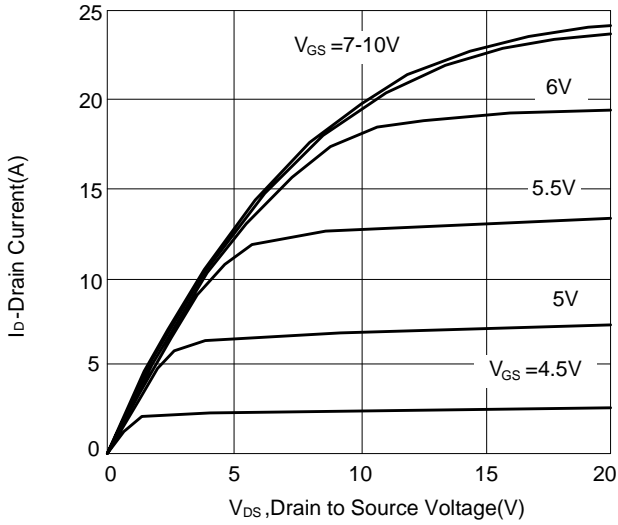


Figure 1: Output Characteristics

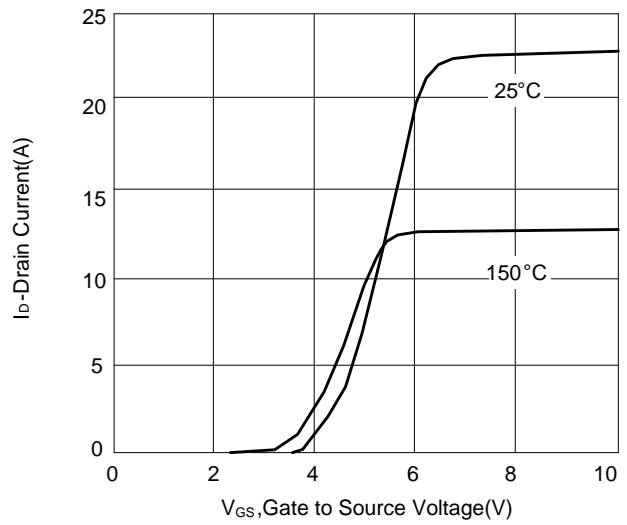


Figure 2: Transfer Characteristics

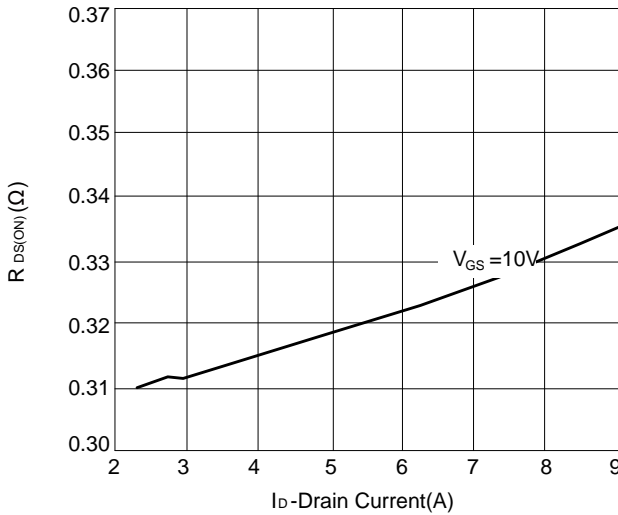


Figure 3: Drain to Source On-Resistance vs Drain Current

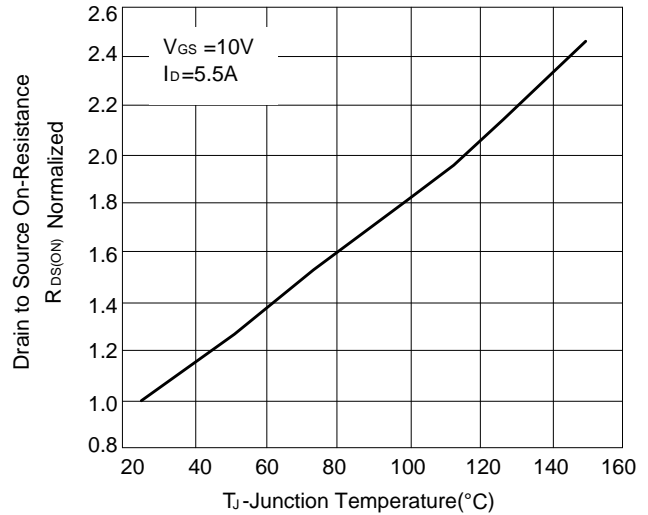


Figure 4: Drain to Source On-Resistance vs Junction Temperature

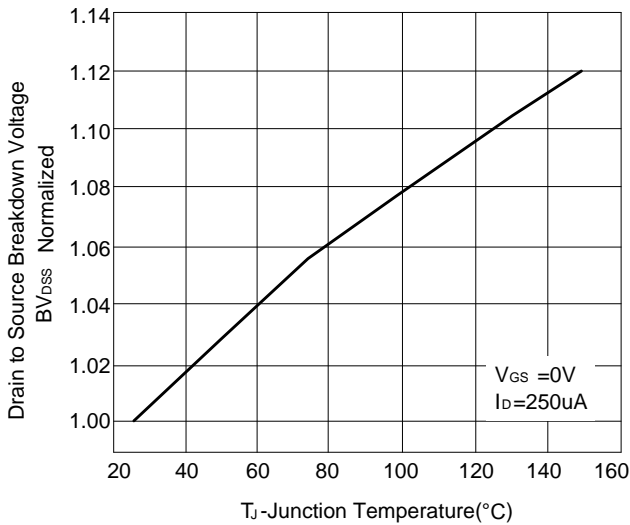


Figure 5: Breakdown Voltage vs Junction Temperature

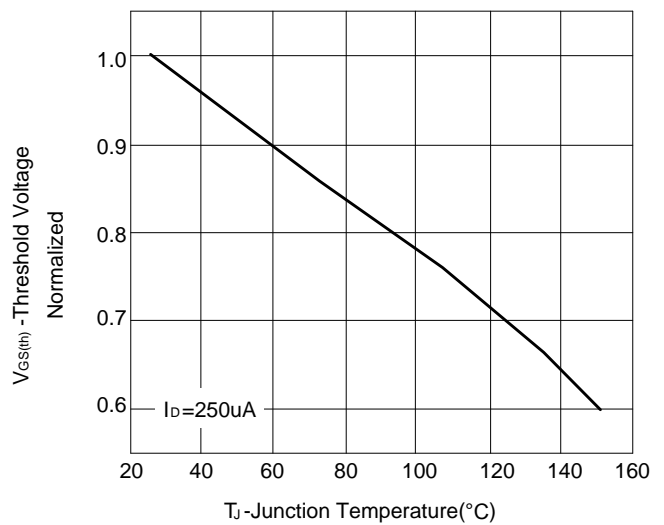


Figure 6: Threshold Voltage vs Junction Temperature

■ TYPICAL CHARACTERISTICS(Cont.)

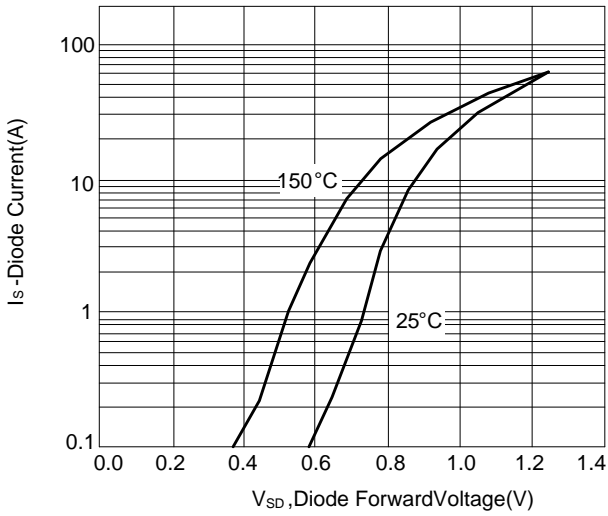


Figure 7: Gate Charge Characteristics

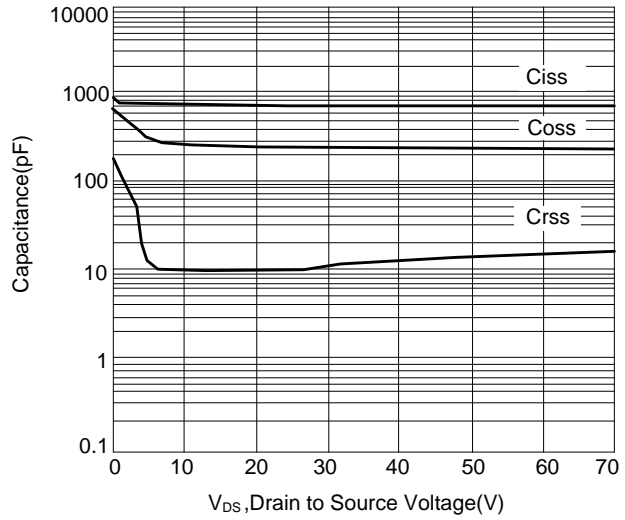


Figure 8: Capacitance Characteristics

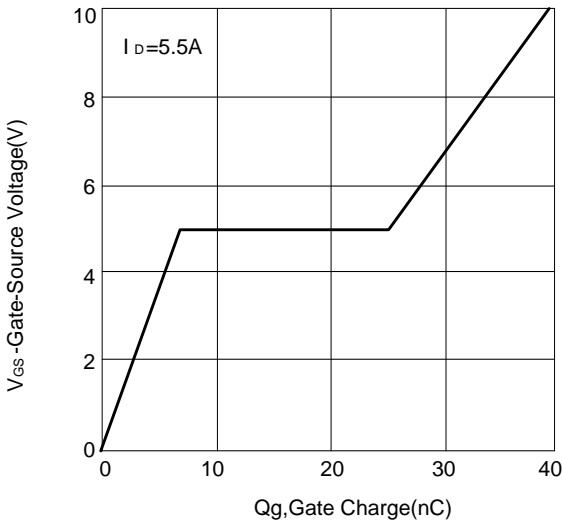


Figure 9: Gate Charge Characteristics

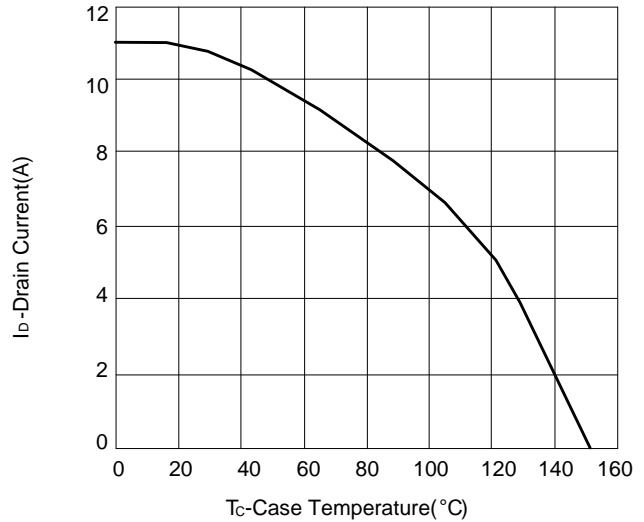


Figure 10: Drain Current Derating

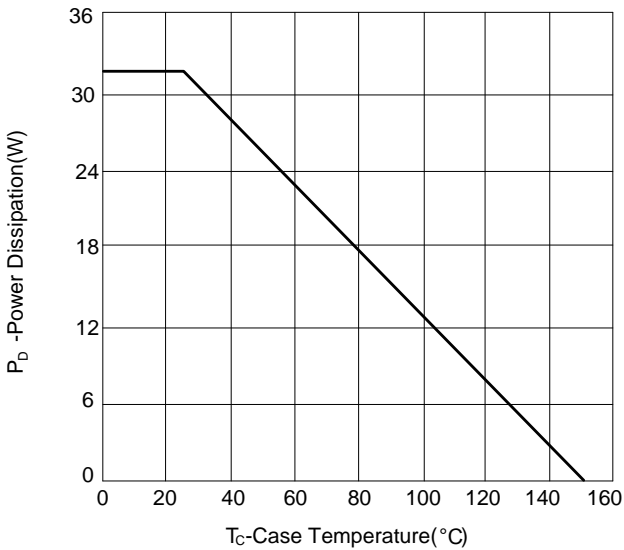


Figure 11: Power Dissipation vs. Case Temperature

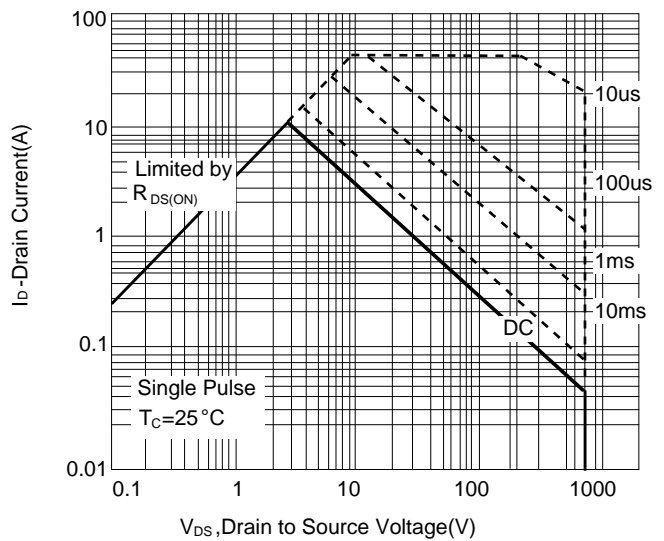


Figure 12: Safe operating Area

